

# Surface Mount Multilayer Varistor

## SC0402ML - SC0603ML Series

### Description

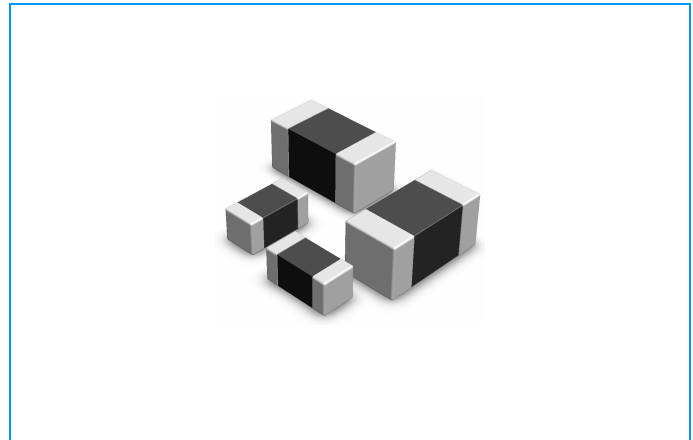
The SC Series is based on Multilayer fabrication technology. These components are designed to suppress a variety of transient events, including those specified in IEC 61000-4-2 or other standards used for Electromagnetic Compliance (EMC). The SC Series is typically applied to protect integrated circuits and other components at the circuit board level. It can operate over a wider temperature range than zener diodes.

### Features

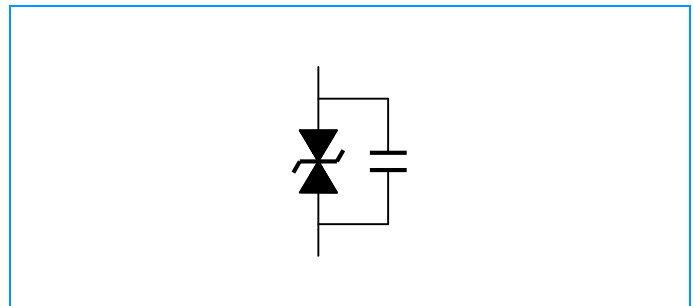
- u SMD type zinc oxide based ceramic chip
- u Lead free plating termination provided good solderability characteristic
- u Insulator overcoat keeps excellent low and stable leakage current
- u Quick response time (<1ns)
- u Low clamping voltage
- u High transient current capability
- u Meet IEC 61000-4-2 standard
- u Compact size for EIA 0402, 0603

### Applicable

- u Application for Mother Board, Notebook, Cellular Phone, PDA, handheld device, DSC, DV, Scanner, and Set- Top Box...etc.
- u Suitable for Push-Button, Power Line and Low Frequency single line over-voltage protect.



### Equivalent Circuits



### Explanation of Part Number

<b>SC</b>	<b>0402</b>	<b>ML</b>	<b>080</b>	<b>M</b>
(1)	(2)	(3)	(4)	(5)

- (1) Socay Logo
- (2) Chip Size (EIA): 0402 / 0603
- (3) Series Type: ML- Multilayer Varistor
- (4) Varistor Voltage: Value - 080=  $08 \times 10^0 = 8V$ , 120=  $12 \times 10^0 = 12V$
- (5) Varistor Voltage Tolerance: N -  $\pm 30\%$ , M -  $\pm 20\%$ , L -  $\pm 15\%$ , K -  $\pm 10\%$

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#### Electrical Characteristics (25±5° C)

##### SC0402ML Series

Symbol	Working Voltage		Varistor Voltage		Clamping Voltage	Capacitance	Peak Current	Transient Energy
	$V_{RMS}$	$V_{DC}$	$V_V$	$\Delta V_V$	$V_C$	$C_P$	$I_{max}$	$W_{max}$
Units	Volts (Max.)	Volts (Max.)	Volts	%	Volts (Max.)	pF (Typical)	Amps (Max.)	Joules (Max.)
SC0402ML080M	4	5.5	8	±20	19	270	20	0.05
SC0402ML120M	7	9	12.5	±20	32	130	20	0.05
SC0402ML150L	8	11	15	±15	33	120	20	0.05
SC0402ML180K	11	14	18	±10	38	90	20	0.05
SC0402ML220K	14	18	22	±10	45	85	20	0.05

##### SC0603ML Series

Symbol	Working Voltage		Varistor Voltage		Clamping Voltage	Capacitance	Peak Current	Transient Energy
	$V_{RMS}$	$V_{DC}$	$V_V$	$\Delta V_V$	$V_C$	$C_P$	$I_{max}$	$W_{max}$
Units	Volts (Max.)	Volts (Max.)	Volts	%	Volts (Max.)	pF (Typical)	Amps (Max.)	Joules (Max.)
SC0603ML080M	4	5.5	8	±20	19	270	30	0.1
SC0603ML120M	7	9	12.5	±20	27	210	30	0.1
SC0603ML150L	8	11	15	±15	33	200	30	0.1
SC0603ML180K	11	14	18	±10	35	150	30	0.1
SC0603ML220K	14	18	22	±10	40	130	30	0.1
SC0603ML310K	20	26	31	±10	58	100	30	0.1

$V_{RMS}$  – Maximum AC operating voltage the varistor can maintain and not exceed 10µA leakage current

$V_{DC}$  – Maximum DC operating voltage the varistor can maintain and not exceed 10µA leakage current

$V_V$  – Voltage across the device measure at 1mA DC current.

Equivalent to  $V_B$  “breakdown voltage”

$V_C$  – Maximum peak current across the varistor with 8/20µs waveform and 1A pulse current.

$C_P$  – Device capacitance measured with zero volt bias 1Vrms at 1MHz.

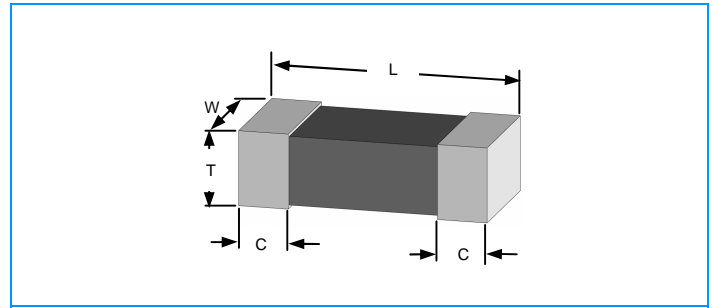
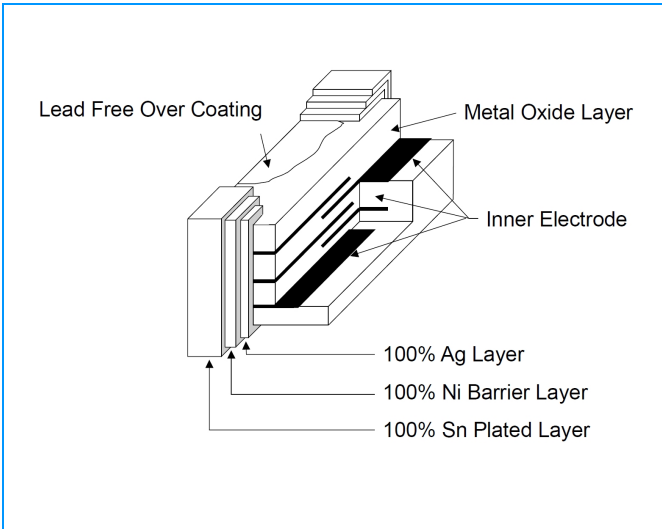
$I_{max}$  – Maximum peak current which may be applied with 8/20µs waveform without device failure.

$W_{max}$  – Maximum energy which may be dissipated with the 10/1000µs waveform without device failure.

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### Construction & Dimensions



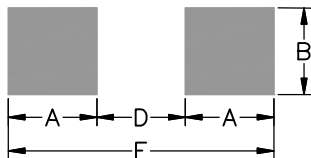
Size EIA (EIAJ)	0402 (1005)		0603 (1608)	
	Inches	Millimeters	Inches	Millimeters
<b>L</b>	0.038±0.005	0.96±0.12	0.063±0.006	1.60±0.15
<b>W</b>	0.019±0.003	0.48±0.07	0.031±0.004	0.80±0.10
<b>T</b>	0.020±0.004	0.50±0.10	0.031±0.008	0.80±0.20
<b>C</b>	0.010±0.006	0.25±0.15	0.012±0.008	0.30±0.20

### Pad Layouts & Precaution for handling of substrate

#### Solder cream in reflow soldering

Refer to the recommendable land pattern as printing mask pattern for solder cream.

(1) Print solder in a thickness of 150 to 200µm



#### Precaution for handling of substrate

Do not exceed to bend the board after soldering this product extremely. (reference examples)

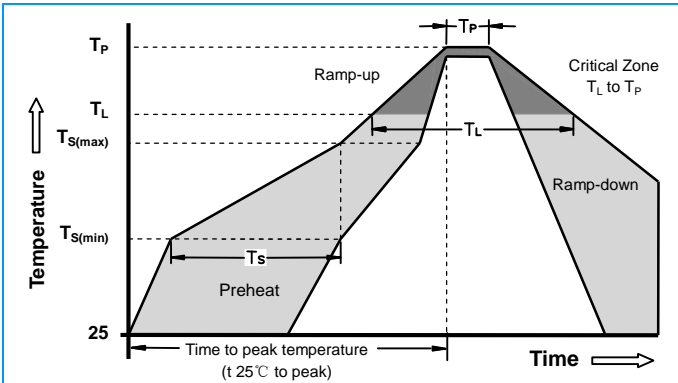
- I Mounting place must be as far as possible from the position, which is close to the break line of board or on the line of large holes of board.
- I Do not bend extremely the board, in mounting another component. If necessary, use back-up pin (support pin) to prevent from bending extremely.
- I Do not break the board by hand. We recommend to use the machine or the jig to break it.

Size EIA (EIAJ)	0402 (1005)		0603 (1608)	
	Inches	Millimeters	Inches	Millimeters
<b>A</b>	0.024	0.61	0.040	1.02
<b>B</b>	0.020	0.51	0.030	0.76
<b>D</b>	0.020	0.51	0.020	0.50
<b>E</b>	0.067	1.70	0.100	2.54

# Surface Mount Multilayer Varistor

## SC0402ML - SC0603ML Series

### Soldering Parameters



### Precaution for soldering

Note that this product will be easily damaged by rapid heating, rapid cooling or local heating.

Do not give heat shock over 100°C in the process of soldering. We recommend to take preheating and gradual cooling

### Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

- 1) The tip temperature must be less than 280 for the period within 3 seconds by using soldering gun under 30W
- 2) The soldering gun tip shall not touch this product directly.

### Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.

Reflow Condition		Pb-Free assembly
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max ( $T_{s(max)}$ )	+200°C
	-Time (min to max) ( $T_s$ )	60 -180 Seconds
Average ramp up rate ( Liquidus Temp $T_L$ ) to peak		3°C/Second Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/Second Max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	+217°C
	- Time (min to max) ( $T_L$ )	60 -150 Seconds
Peak Temperature ( $T_P$ )		260 +0/-5°C
Time within 5°C of actual peak Temperature ( $T_P$ )		20-40 Seconds
Ramp-down Rate		6°C/Second Max
Time 25°C to peak Temperature ( $T_P$ )		8 minutes Max

### General Technical Data

Operating Temperature		-40 ~ +85°C
Storage Temperature		-40 ~ +85°C
Response Time		<1 ns
Solderability		245±5°C, 3±1sec
Solder leach resistance		260±5°C, 10±1sec
Taping Package Storage Condition	Storage Temperature	5 ~ 40°C
	Relative Humidity	To 65%
	Storage Time	12 Months max

### Environmental Performance

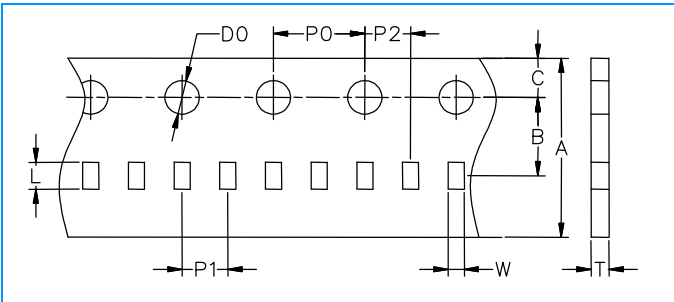
Item	Specifications	Test Condition
Bias Humidity	$\Delta V_V / V_V \leq \pm 10 \%$	90%RH, 40°C, Working Voltage, 1000 hrs
Thermal Shock	$\Delta V_V / V_V \leq \pm 10 \%$	-40°C to 85°C, 30 min. cycle, 5 cycles
Full Load Voltage	$\Delta V_V / V_V \leq \pm 10 \%$	Working Voltage, 85°C, 1000 hrs

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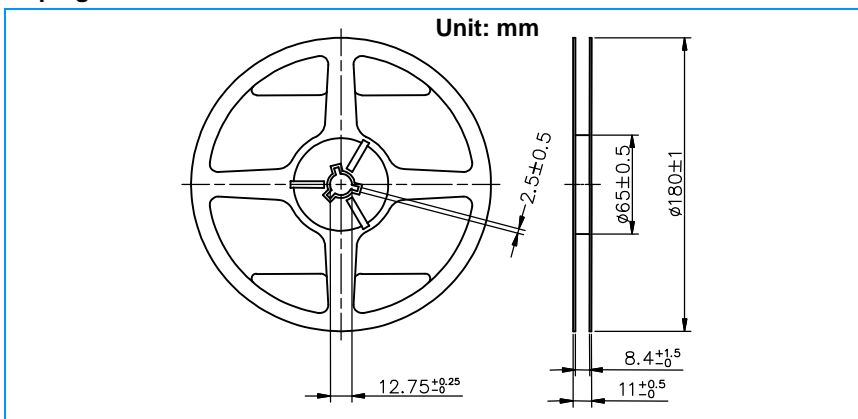
### Packaging Information

#### Carrier Tape Dimensions



Size EIA (EIAJ)	0402 (1005)		0603 (1608)	
	Inches	Millimeters	Inches	Millimeters
<b>A</b>	0.315±0.012	8.00±0.30	0.315±0.012	8.00±0.30
<b>B</b>	0.138±0.002	3.50±0.05	0.138±0.002	3.50±0.05
<b>C</b>	0.069±0.002	1.75±0.05	0.069±0.002	1.75±0.10
<b>D0</b>	0.061±0.002	1.55±0.05	0.061±0.002	1.55±0.05
<b>P0</b>	0.157±0.004	4.00±0.10	0.157±0.004	4.00±0.10
<b>P1</b>	0.079±0.002	2.00±0.05	0.079±0.002	4.00±0.10
<b>P2</b>	0.079±0.002	2.00±0.05	0.079±0.002	2.00±0.05
<b>W</b>	0.023±0.001	0.59±0.03	0.041±0.006	1.05±0.15
<b>L</b>	0.044±0.001	1.12±0.03	0.075±0.006	1.90±0.15
<b>T</b>	0.024±0.001	0.60±0.03	0.037±0.002	0.95±0.05

#### Taping Reel Dimensions



#### Taping Specifications

There shall be the portion having no product in both the head and the end of taping, and there shall be the cover tape in the heat of taping.

#### Quantity of products in the taping package

SIZE EIA (EIAJ)	0402 (1005)	0603 (1608)
<b>Standard Packing Quantity (PCS / reel)</b>	10,000	4,000

#### The contents of a box :

0402 Series: 6 reels / inner box  
0603 Series: 6 reels / inner box